Справочный раздел Интернет Портала «Радиодар»

ТЕХНИЧЕСКИЙ СПРАВОЧНИК «мощный IGBT транзистор FGH60N60SFD производства фирмы Texas Instruments»

Версия:	1
Ревизия:	4.0.0
Дата:	2024 г.



«Радиодар» 2024

Onsemi

IGBT - Field Stop 600 V, 60 A FGH60N60SMD

Ι _C
60 A

Description

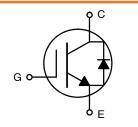
Using novel field stop IGBT technology, **onsemi**'s new series of field stop 2nd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

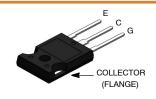
Features

- Maximum Junction Temperature: T_J = 175°C
- Positive Temperature Co-efficient for easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.9 V (Typ.) @ I_C = 60 A$
- High Input Impedance
- Fast Switching: E_{OFF} = 7.5 uJ/A
- Tightened Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant

Applications

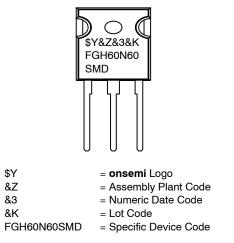
• Solar Inverter, UPS, Welder, PFC, Telecom, ESS





TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit	
V _{CES}	Collector to Emitter Voltage		600	V	
V _{GES}	Gate to Emitter Voltage		±20	V	
	Transient Gate to Emitter Voltage		±30	V	
Ι _C	$I_{\rm C}$ Collector Current $T_{\rm C} = 25^{\circ}{\rm C}$		120	А	
		T _C = 100°C	60	А	
I _{CM} (Note 1)	Pulsed Collector Current	Ised Collector Current		А	
١ _F	Diode Forward Current	T _C = 25°C	60	А	
		T _C = 100°C	30	А	
I _{FM} (Note 1)	Pulsed Diode Maximum Forward Curr	rent	180	А	
PD	Maximum Power Dissipation	T _C = 25°C	600	W	
		T _C = 100°C	300	W	
TJ	Operating Junction Temperature	Operating Junction Temperature		°C	
T _{STG}	Storage Temperature Range		–55 to +175	°C	
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.25	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.1	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Qty per Tube
FGH60N60SMD	FGH60N60SMD	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARAC	TERISTICS				•	
BV _{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I_C = 250 μ A	600	-	-	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 250 μA	-	0.6	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0 V	-	-	±400	nA
ON CHARACT	ERISTICS					
V _{GE(th)}	G-E Threshold Voltage	I_C = 250 μ A, V_{CE} = V_{GE}	3.5	4.5	6.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 60 A, V _{GE} = 15 V,	-	1.9	2.5	V
		I _C = 60 A, V _{GE} = 15 V, T _C = 175°C	-	2.1	-	v
YNAMIC CHA	ARACTERISTICS			.		
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V,	-	2915	-	pF
C _{oes}	Output Capacitance	f = 1 MHz	_	270	-	pF
C _{res}	Reverse Transfer Capacitance		-	85	-	pF
WITCHING C	HARACTERISTICS					
T _{d(on)}	Turn-On Delay Time	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 400 \; V, \; I_C = 60 \; A, \\ R_G = 3 \; \Omega, \; V_{GE} = 15 \; V, \\ Inductive \; Load, \; T_C = 25^\circ C \end{array}$	-	18	27	ns
Tr	Rise Time		_	47	70	ns
T _{d(off)}	Turn-Off Delay Time		_	104	146	ns
T _f	Fall Time		-	50	68	ns
Eon	Turn-On Switching Loss		-	1.26	1.94	mJ
E _{off}	Turn–Off Switching Loss		_	0.45	0.6	mJ
E _{ts}	Total Switching Loss		-	1.71	2.54	mJ
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 60 \text{ A},$	-	18	-	ns
Tr	Rise Time	$R_G = 3 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 175^{\circ}C$	-	41	-	ns
T _{d(off)}	Turn-Off Delay Time		-	115	-	ns
T _f	Fall Time		_	48	-	ns
Eon	Turn–On Switching Loss		-	2.1	-	mJ
E _{off}	Turn-Off Switching Loss	-	-	0.78	-	mJ
E _{ts}	Total Switching Loss		-	2.88	-	mJ
Qg	Total Gate Charge	$V_{CE} = 400 \text{ V}, I_{C} = 60 \text{ A},$	-	189	284	nC
Q _{ge}	Gate to Emitter Charge	V _{GE} = 15 V	-	20	30	nC
Q _{gc}	Gate to Collector Charge		_	91	137	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

_	ELECTRICAL	CHARACTERISTICS OF THE DIOL	DE (T _C = 25°C unless otherwise)	se noted)
	Symbol	Parameter	Test Conditions	Min

Symbol	Parameter	Test Co	Test Conditions		Тур	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 30 A	$T_{\rm C} = 25^{\circ}{\rm C}$	-	2.1	2.7	V
			T _C = 175°C	-	1.7	-	
E _{rec}	Reverse Recovery Energy	I _F = 30 A, di _F /dt = 200 A/μs	T _C = 175°C	-	79	-	uJ
T _{rr}	Diode Reverse Recovery Time	ui _F /ut = 200 Α/μ3	$T_{\rm C} = 25^{\circ}{\rm C}$	-	30	39	ns
			$T_{\rm C} = 175^{\circ}{\rm C}$	-	72	-	
Q _{rr}	Diode Reverse Recovery Charge	7	$T_{\rm C} = 25^{\circ}{\rm C}$	-	44	62	nC
			T _C = 175°C	-	238	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

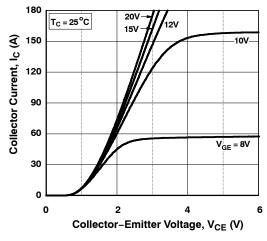
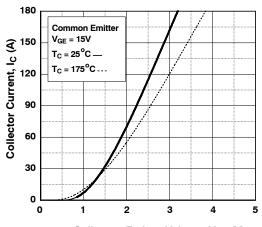


Figure 1. Typical Output Characteristics



Collector-Emitter Voltage, V_{CE} (V)

Figure 3. Typical Saturation Voltage Characteristics

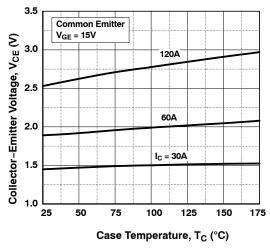


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

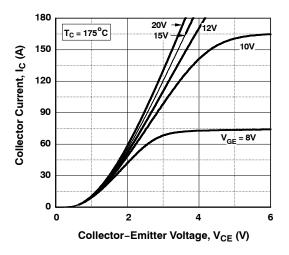
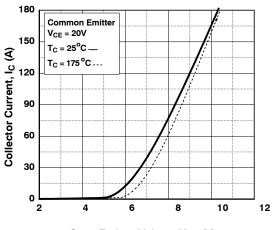


Figure 2. Typical Output Characteristics



Gate-Emitter Voltage, V_{GE} (V)

Figure 4. Transfer Characteristics

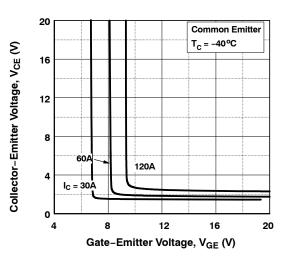


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

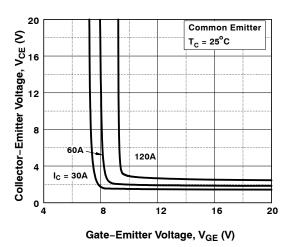
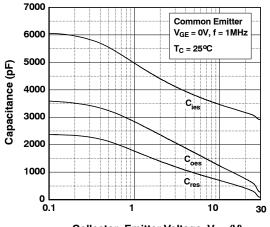


Figure 7. Saturation Voltage vs. V_{GE}



Collector-Emitter Voltage, V_{CE} (V)

Figure 9. Capacitance Characteristics

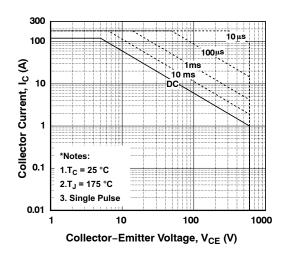
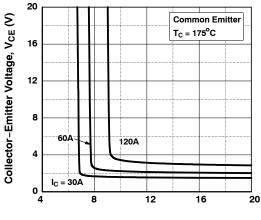


Figure 11. SOA Characteristics



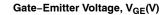


Figure 8. Saturation Voltage vs. V_{GE}

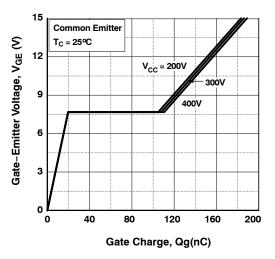
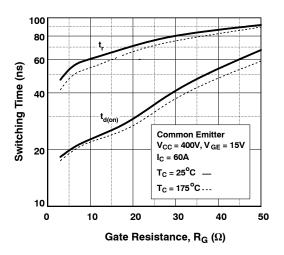
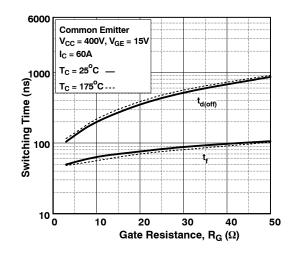


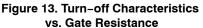
Figure 10. Gate Charge Characteristics

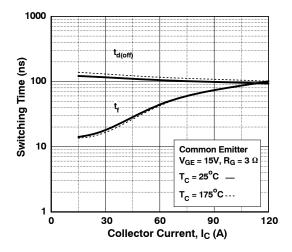




TYPICAL PERFORMANCE CHARACTERISTICS (Continued)









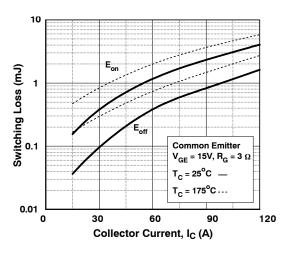


Figure 17. Switching Loss vs. Collector Current

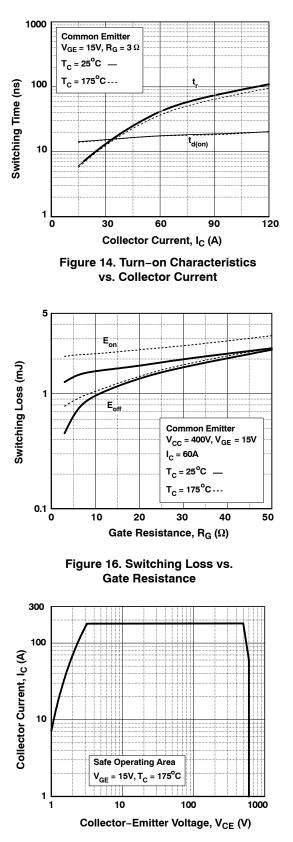
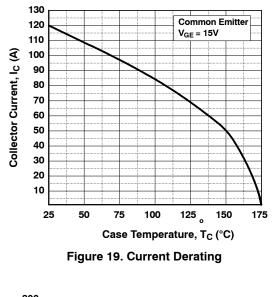


Figure 18. Turn Off Switching SOA Characteristics

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



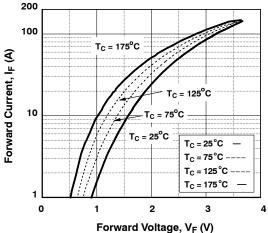


Figure 21. Forward Characteristics

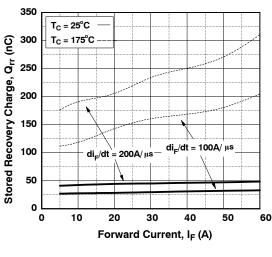
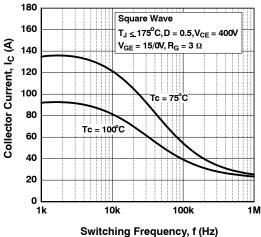


Figure 23. Stored Charge



5 1 5 ()

Figure 20. Load Current vs. Frequency

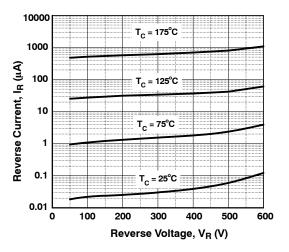


Figure 22. Reverse Current

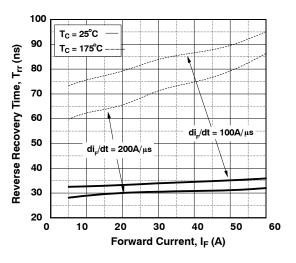


Figure 24. Reverse Recovery Time

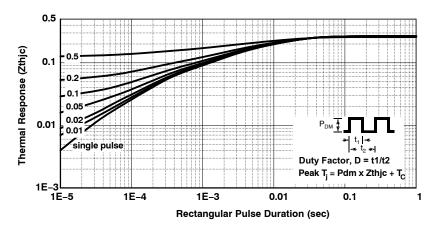


Figure 25. Transient Thermal Impedance of IGBT

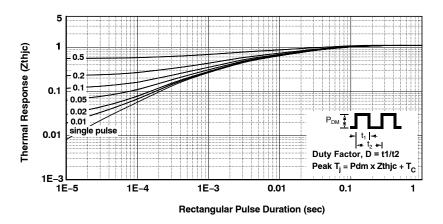
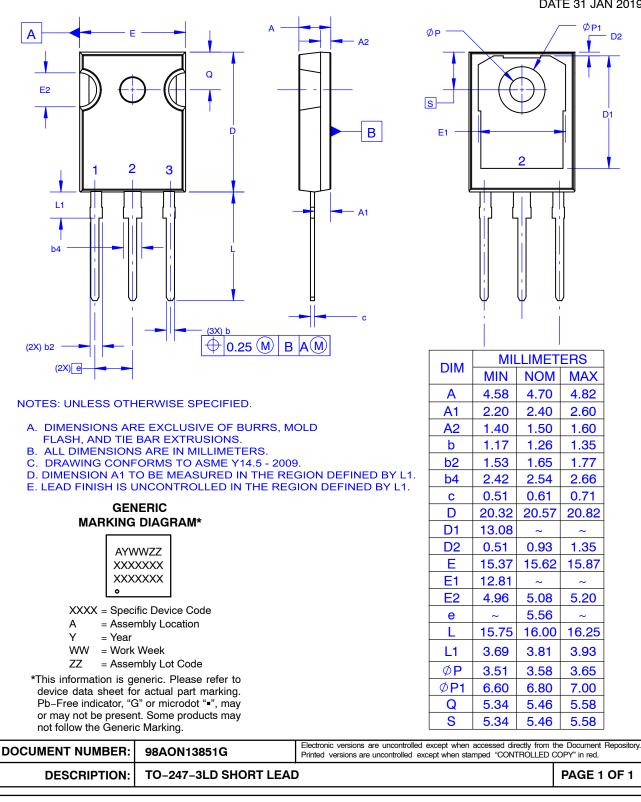


Figure 26. Transient Thermal Impedance of Diode



TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A**

DATE 31 JAN 2019



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